

FMMTL718TC Datasheet



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DiGi Electronics Part Number	FMMTL718TC-DG
Manufacturer	Diodes Incorporated
Manufacturer Product Number	FMMTL718TC
Description	TRANS PNP 20V 1A SOT23-3
Detailed Description	Bipolar (BJT) Transistor PNP 20 V 1 A 265MHz 500 mW Surface Mount SOT-23-3



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Purchase and inquiry

Manufacturer Product Number:

FMMTL718TC

Series:

-

Transistor Type:

PNP

Voltage - Collector Emitter Breakdown (Max):

20 V

Current - Collector Cutoff (Max):

10nA

Power - Max:

500 mW

Operating Temperature:

-55°C ~ 150°C (TJ)

Package / Case:

TO-236-3, SC-59, SOT-23-3

Base Product Number:

FMMTL718

Manufacturer:

Diodes Incorporated

Product Status:

Obsolete

Current - Collector (Ic) (Max):

1 A

Vce Saturation (Max) @ Ib, Ic:

450mV @ 100mA, 1.5A

DC Current Gain (hFE) (Min) @ Ic, Vce:

200 @ 500mA, 2V

Frequency - Transition:

265MHz

Mounting Type:

Surface Mount

Supplier Device Package:

SOT-23-3

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.21.0075

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



FMRTL718

20V PNP SILICON LOW SATURATION TRANSISTOR IN SOT23

Features and Benefits

- $BV_{CEO} > -20V$
- $I_C = -1A$ Continuous Collector Current
- $I_{CM} = -2A$ Peak Pulse Current
- Low Saturation Voltage $V_{CE(sat)} < -320mV @ -1A$
- h_{FE} characterised up to $-1.5A$ for high current gain hold-up
- 500mW power dissipation
- Complementary part number FMRTL618
- **Lead Free, RoHS Compliant (Note 1)**
- **Halogen and Antimony Free "Green" Device (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT-23
- UL Flammability Rating 94V-0
- Case material: molded Plastic.
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish annealed over Copper plated Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.008 grams (Approximate)

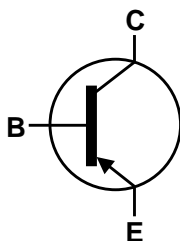
Applications

- MOSFET Gate Driving
- DC-DC Converters
- Charging circuit
- Power switches

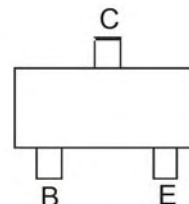
SOT23



Top View



Device Symbol



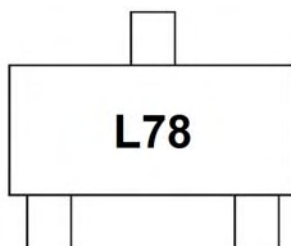
Top View
Pin-Out

Ordering Information (Note 3)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FMRTL718TA	L78	7	8	3,000

- Notes:
1. No purposefully added lead.
 2. Diodes Inc.'s "Green" Policy can be found on our website at <http://www.diodes.com>
 3. For Packaging Details, go to our website at <http://www.diodes.com>.

Marking Information



L78 = Product Type Marking Code



FMRTL718

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-20	V
Collector-Emitter Voltage	V_{CEO}	-20	V
Emitter-Base Voltage	V_{EBO}	-5	V
Continuous Collector Current	I_C	-1	A
Peak Pulse Current	I_{CM}	-2	A
Base Current	I_B	-200	mA

Thermal Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P_D	500	mW
Thermal Resistance, Junction to Ambient (Note 4)	$R_{\theta JA}$	250	$^\circ\text{C/W}$
Thermal Resistance, Junction to Lead (Note 5)	$R_{\theta JL}$	197	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

- Notes:
4. For a device surface mounted on 15mm X 15mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 5. Thermal resistance from junction to solder-point (at the end of the collector lead).

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

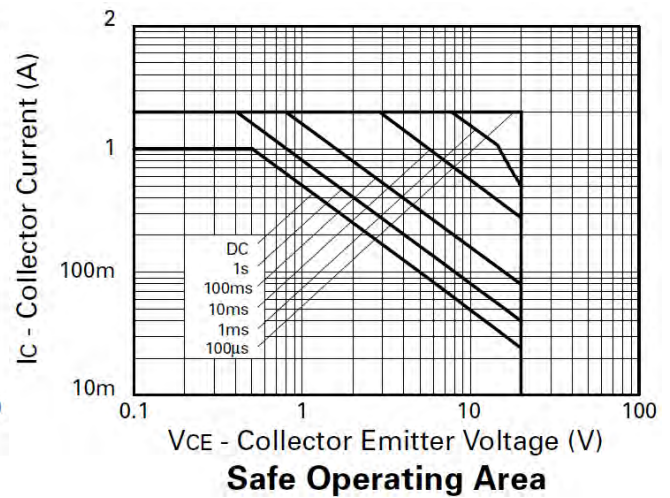
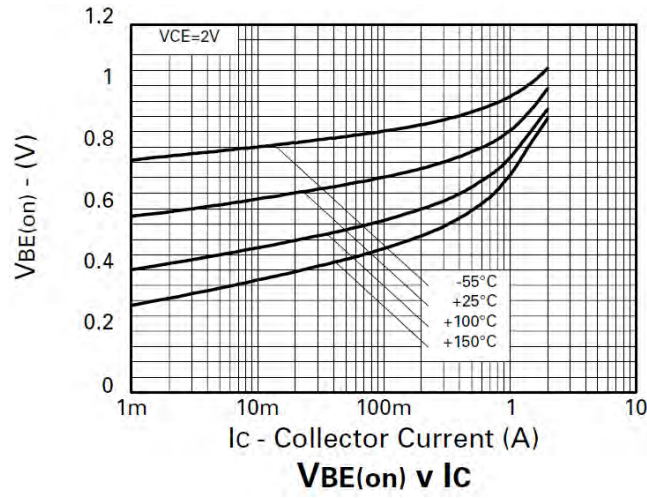
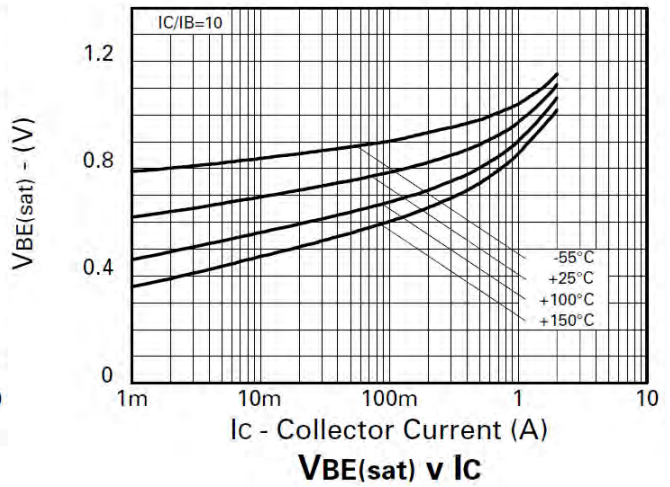
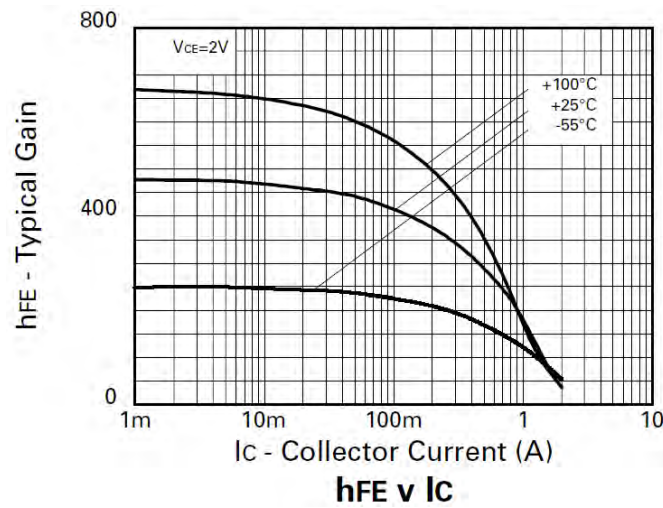
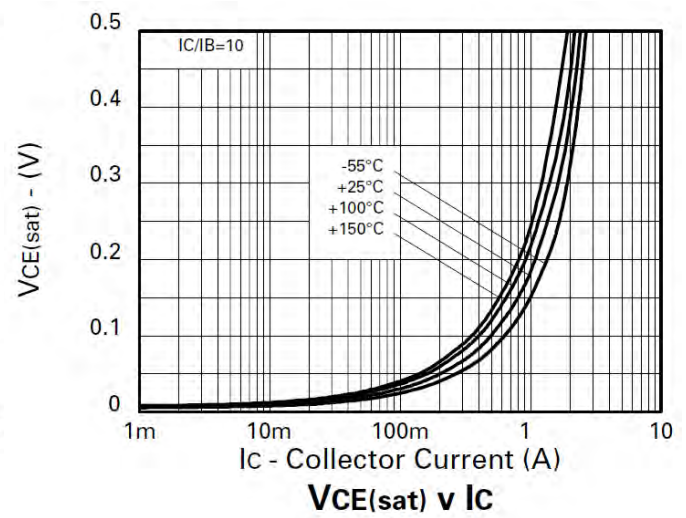
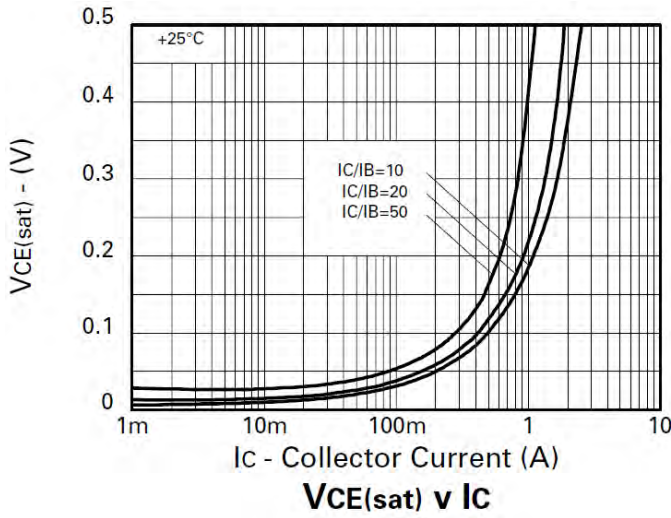
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	-20	-65		V	$I_C = -100 \mu\text{A}$
Collector-Emitter Breakdown Voltage (Note 6)	BV_{CEO}	-20	-55		V	$I_C = -10 \text{ mA}$
Emitter-Base Breakdown Voltage	BV_{EBO}	-5	-8.8		V	$I_E = -100 \mu\text{A}$
Collector Cutoff Current	I_{CBO}			-10	nA	$V_{CB} = -15\text{V}$
Emitter Cutoff Current	I_{EBO}			-10	nA	$V_{EB} = -4\text{V}$
Collector Emitter Cutoff Current	I_{CES}			-10	nA	$V_{CE} = -15\text{V}$
Static Forward Current Transfer Ratio (Note 6)	h_{FE}	300 300 200 120 50	500 450 320 200 80			$I_C = -10\text{mA}, V_{CE} = -2\text{V}$ $I_C = -100\text{mA}, V_{CE} = -2\text{V}$ $I_C = -0.5\text{A}, V_{CE} = -2\text{V}$ $I_C = -1\text{A}, V_{CE} = -2\text{V}$ $I_C = -1.5\text{A}, V_{CE} = -2\text{V}$
Collector-Emitter Saturation Voltage (Note 6)	$V_{CE(sat)}$		-33 -130 -230 -315	-50 -180 -320 -450	mV mV mV mV	$I_C = -100\text{mA}, I_B = -10\text{mA}$ $I_C = -500\text{mA}, I_B = -20\text{mA}$ $I_C = -1\text{A}, I_B = -50\text{mA}$ $I_C = -1.5\text{A}, I_B = -100\text{mA}$
Base-Emitter Turn-On Voltage (Note 6)	$V_{BE(on)}$		-0.85	-1.0	V	$I_C = -1.25\text{A}, V_{CE} = -2\text{V}$
Base-Emitter Saturation Voltage (Note 6)	$V_{BE(sat)}$		-0.95	-1.1	V	$I_C = -1.25\text{A}, I_B = -100\text{mA}$
Equivalent On-Resistance	$R_{CE(sat)}$		210		m Ω	$I_C = -1.5\text{A}$
Output Capacitance	C_{obo}		9	12	pF	$V_{CB} = -10\text{V}, f = 1\text{MHz}$
Transition Frequency	f_T		265		MHz	$V_{CE} = -10\text{V}, I_C = -50\text{mA}, f = 100\text{MHz}$
Turn-On Time	t_{on}		108		ns	$V_{CC} = -10\text{V}, I_C = -1\text{A}$
Turn-Off Time	t_{off}		121		ns	$I_{B1} = I_{B2} = -10\text{mA}$

- Note: 6. Measured under pulsed conditions. Pulse width $\leq 300 \mu\text{s}$. Duty cycle $\leq 2\%$

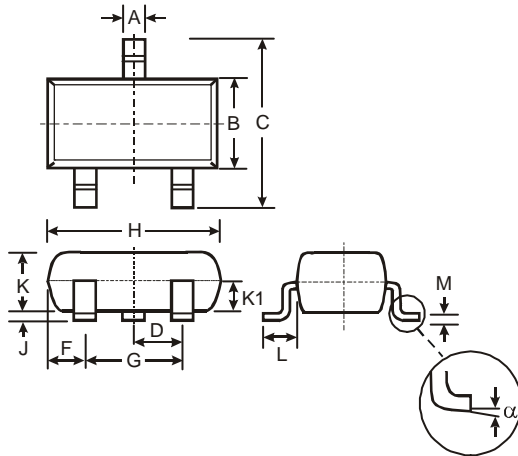


FMMTL718

Typical Electrical Characteristics

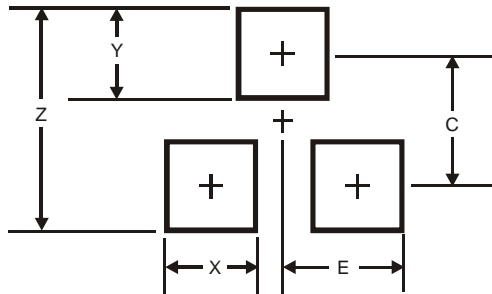


Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35



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